



### **Product Summary**

V(BR)DSS	Rds(on)	I <sub>D</sub> T <sub>A</sub> = +25°C
50V	1.8Ω @ V <sub>GS</sub> = 10V	500mA
	$2.0\Omega @ V_{GS} = 4.5V$	450mA

## **Description and Applications**

This new generation MOSFET has been designed to minimize the onstate resistance (R<sub>DS(ON)</sub>) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Backlighting
- DC-DC Converters
- Power Management Functions

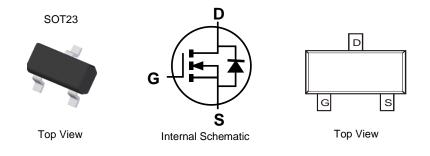
### N-CHANNEL ENHANCEMENT MODE FIELD MOSFET

### **Features and Benefits**

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

### **Mechanical Data**

- Case: SOT23
- Case Material: Molded Plastic "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 (3)
- Terminal Connections: See Diagram
- Weight: 0.008 grams (Approximate)



### Ordering Information (Note 4)

Part Number	Qualification	Case	Packaging
BSN20-7	Standard	SOT23	3000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**

N20	ΜY

N20 = Product Type Marking Code YM = Date Code Marking Y or  $\overline{Y}$  = Year (ex: G = 2019) M = Month (ex: 9 = September)

#### Date Code Key

Date Obue I	хсу												
Year	2009	-	201	19 20	)20 2	021	2022	2023	2024	2025	2026	2027	2028
Code	W	-	G	i	H		J	K	L	М	Ν	0	Р
Mon	th	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Cod	6	1	2	3	4	5	6	7	8	q	0	N	D



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Charac	teristic		Symbol	Value	Unit
Drain-Source Voltage			VDSS	50	V
Gate-Source Voltage			V <sub>GSS</sub>	±20	V
Continuous Drain Current @ T <sub>SP</sub> = +25°C (Note 5)				500 300	mA
Pulsed Drain Current @ Tsp = +2	25°C (Notes 5 & 6)		Ідм	1.2	А

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation, $@T_A = +25^{\circ}C$ (Note 5)	PD	600	mW
Thermal Resistance, Junction to Ambient $@T_A = +25^{\circ}C$ (Note 5)	R <sub>θJA</sub>	200	°C/W
Power Dissipation, $@T_{SP} = +25^{\circ}C$ (Note 5)	PD	920	mW
Thermal Resistance, @T <sub>SP</sub> = +25°C (Note 5)	Rejsp	136	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

### Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	50	—	—	V	$V_{GS} = 0V, I_{D} = 250 \mu A$	
Zero Gate Voltage Drain Current TJ = +25°C	IDSS		_	0.5	μA	V <sub>DS</sub> = 50V, V <sub>GS</sub> = 0V	
Gate-Body Leakage	lgss		_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)			•				
Gate Threshold Voltage	Vgs(th)	0.4	1.0	1.5	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance	Rds(on)	_	1.3 1.6	1.8 2.0	Ω	V <sub>GS</sub> = 10V, I <sub>D</sub> = 0.22A V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 0.1A	
Forward Transfer Admittance	Y <sub>fs</sub>	40	320	—	mS	V <sub>DS</sub> = 10V, I <sub>D</sub> = 0.1A	
Diode Forward Voltage	V <sub>SD</sub>	_	1.0	1.5	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 180mA	
Source (Diode Forward) Current	Is	_	—	194	mA	T <sub>SP</sub> = +25°C	
Peak Source (Diode Forward) Current	I <sub>SM</sub>	_	—	1.2	А	T <sub>SP</sub> = +25°C	
DYNAMIC CHARACTERISTICS (Note 8)			•			·	
Input Capacitance	Ciss	_	21.8	40	pF		
Output Capacitance	Coss	_	5.6	15	pF	$V_{DS} = 10V, V_{GS} = 0V, f = 1.0MHz$	
Reverse Transfer Capacitance	Crss	_	3.3	10	pF		
Gate Resistance	Rg	_	49	—	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge	Qg	_	800	—	рС		
Gate-Source Charge	$Q_{gs}$	_	100	—	рС	$V_{GS} = 10V, V_{DD} = 25V,$ $I_{D} = 250mA$	
Gate-Drain Charge	$Q_{gd}$		100	_	рС		
Turn-On Delay Time	tD(ON)	_	2.93	—	ns		
Turn-On Rise Time	t <sub>R</sub>	_	2.99	—	ns	$V_{DD} = 30V, V_{GEN} = 10V,$	
Turn-Off Delay Time	t <sub>D(OFF)</sub>		9.45	—	ns	$R_{L} = 150\Omega, R_{GEN} = 50\Omega,$ $I_{D} = 0.2A$	
Turn-Off Fall Time	tF	_	8.3	_	ns		

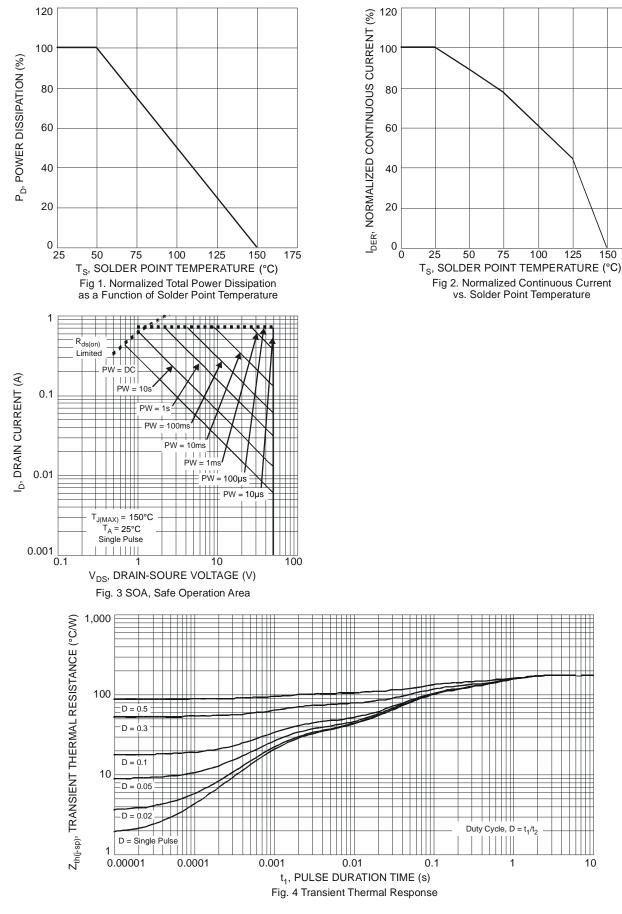
5. Device mounted on FR-4 PCB, with minimum recommended pad layout. Notes:

Repetitive rating, pulse width limited by junction temperature.
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to production testing.

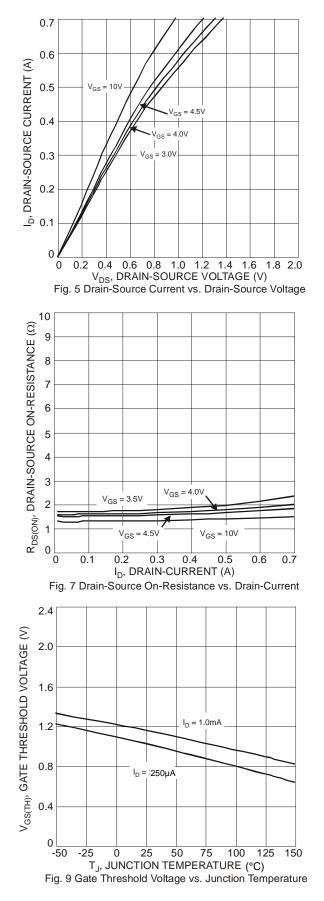


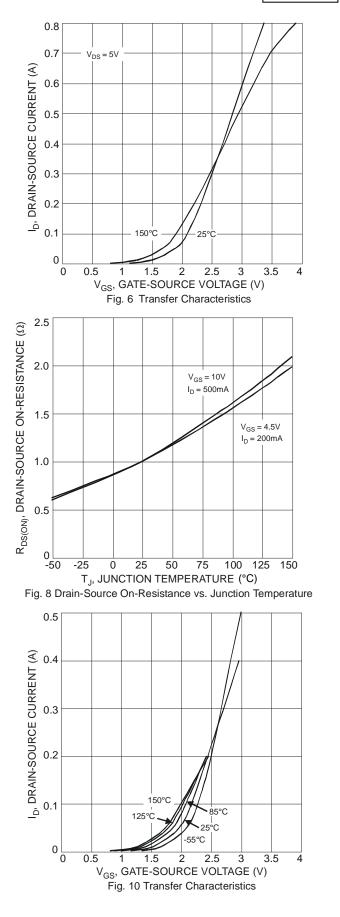
150

175

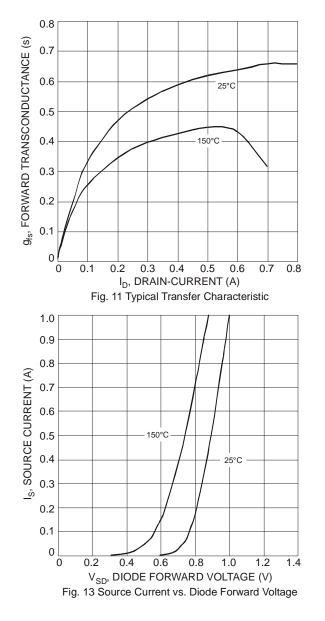


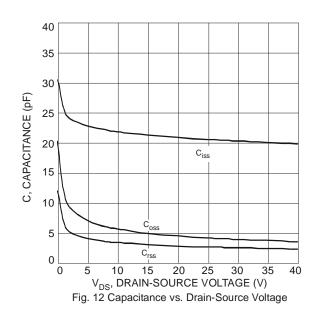








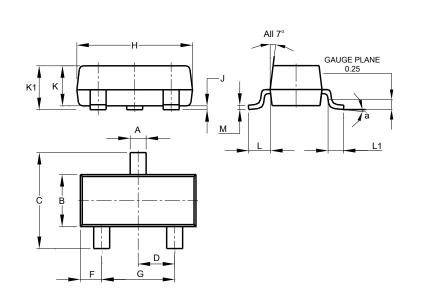






## **Package Outline Dimensions**

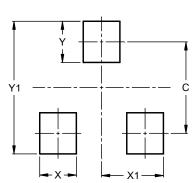
Please see http://www.diodes.com/package-outlines.html for the latest version.



	SOT23						
Dim	Min	Max	Тур				
Α	0.37	0.51	0.40				
В	1.20	1.40	1.30				
c	2.30	2.50	2.40				
D	0.89	1.03	0.915				
F	0.45	0.60	0.535				
G	1.78	2.05	1.83				
H	2.80	3.00	2.90				
J	0.013	0.10	0.05				
К	0.890	1.00	0.975				
K1	0.903	1.10	1.025				
L	0.45	0.61	0.55				
L1	0.25	0.55	0.40				
М	0.085	0.150	0.110				
а	0°	8°					
All	Dimens	ions in	mm				

### **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT23

SOT23

Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Y	0.9
Y1	2.9



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